MA3X704 (MA704), **MA3X704A** (MA704A)

Silicon epitaxial planar type

For switching

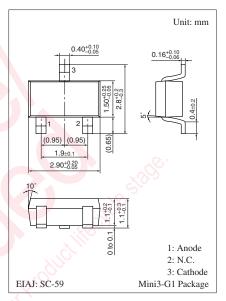
For wave detection

■ Features

- Low forward voltage V_F and good wave detection efficiency η
- Small temperature coefficient of forward characteristic
- Small reverse current I_R

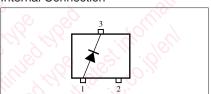
■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit
Reverse voltage	MA3X704	V_R	15	V
	MA3X704A		30	
Maximum peak	MA3X704	V _{RM}	15	V
reverse voltage	MA3X704A		30	
Peak forward current		I_{FM}	150	mA
Forward current		$I_{\rm F}$	30	mA
Junction temperature		T _j	125	°C
Storage temperature		T _{stg}	-55 to +125	°C



Marking Symbol

Note) The part numbers in the parenthesis show conventional part number.

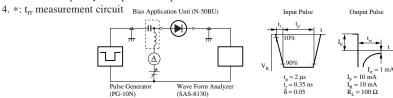


■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage		V_{F1}	$I_F = 1 \text{ mA}$	30	,	0.4	V
		V_{F2}	$I_F = 30 \text{ mA}$	0.9		1.0	
Reverse current	MA3X704	I_R	V _R = 15 V			200	nA
	MA3X704A		$V_R = 30 \text{ V}$			300	
Terminal capacitance	* OLO	C _t	$V_R = 1 \text{ V, f} = 1 \text{ MHz}$		1.5		pF
Reverse recovery time *		t _{rr}	$I_F = I_R = 10 \text{ mA}$		1.0		ns
Mis.			$I_{rr} = 1 \text{ mA}, R_L = 100 \Omega$				
Detection efficiency		η	$V_{IN} = 3 V_{(peak)}$, $f = 30 MHz$ $R_L = 3.9 k\Omega$, $C_L = 10 pF$		65		%

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. Absolute frequency of input and output is 2 GHz.

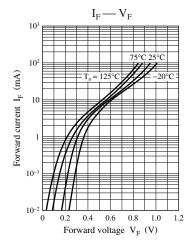
 $R_{\circ} = 50 \Omega$

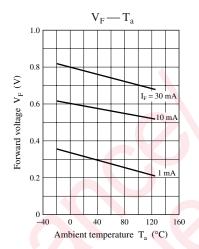


 $R_i = 50 \Omega$

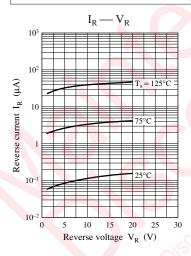
Publication date: April 2004 SKH00073CED 1

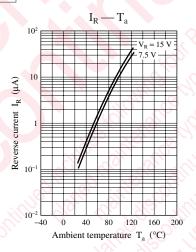
Common characteristics charts

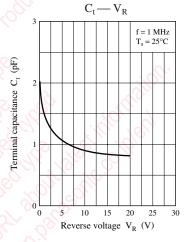




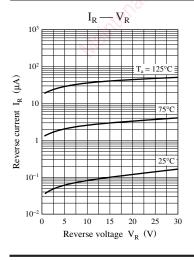
Characteristics charts of MA3X704

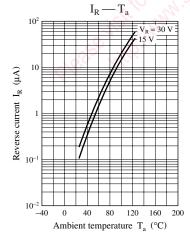


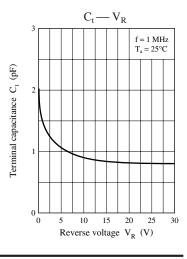




Characteristics charts of MA3X704A







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